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**MARKING** 

**DIAGRAMS** 

Z25 M•



# TinyLogic UHS Buffer with Three-State Output

### **NC7SZ125**

### Description

The NC7SZ125 is a single buffer with three–state output from **onsemi**'s Ultra–High Speed (UHS) of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V range. The inputs and output are high impedance above ground when  $V_{CC}$  is 0 V. Inputs tolerate voltages up to 5.5 V independent of  $V_{CC}$  operating voltage. The output tolerates voltages above  $V_{CC}$  when in the 3–STATE condition.

### **Features**

- Ultra–High Speed:  $t_{PD} = 2.6$  ns (Typical) into 50 pF at 5 V  $V_{CC}$
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX when Operated at 3.3 V V<sub>CC</sub>
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra−Small MicroPak™ Packages
- Space–Saving SOT23–5, SC–74A and SC–88A Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



Figure 1. Logic Symbol

1

# SIP6 CASE 127EB Pin 1 DDKK XYZ DDKK XYZ Pin 1 SC-74A CASE 318BQ 7Z25 M O O TZ25 M O TZ25 M

DD, 7Z25, Z25 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code
XY = 2-Digit Date Code Format
Z = Assembly Plant Code

SC-88A

CASE 419A-02

M = Date CodePb-Free Package

(Microdot may be in either location)

### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

### **Pin Configurations**

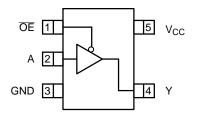


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

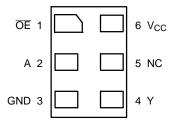


Figure 3. MicroPak (Top Through View)

### **PIN DEFINITIONS**

Pin # SOT23-5 / SC-88A / SC74A	Pin # MicroPak	Name	Description
1	1	ŌĒ	Input
2	2	Α	Input
3	3	GND	Ground
4	4	Υ	Output
5	6	V <sub>CC</sub>	Supply Voltage
	5	NC	No Connect

### **FUNCTION TABLE**

Inp	Output	
ŌĒ	Α	Y
L	L	L
L	Н	Н
Н	X	Z

H = HIGH Logic Level L = LOW Logic Level X = HIGH or LOW Logic Level Z = HIGH Impedance State

### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
I <sub>OUT</sub>	DC Output Current	•	-	±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current		-	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
$T_J$	Junction Temperature Under Bias		-	+150	°C
$T_L$	Junction Lead Temperature (Solo	lering, 10 Seconds)	-	+260	°C
$P_{D}$	Power Dissipation in Still Air	SC-74A / SOT23-5	-	390	mW
		SC-88A	-	332	
		MicroPak-6	-	812	
		MicroPak2™-6	-	812	
ESD	Human Body Model, JEDEC: JESD22-A114		-	4000	V
	Charge Device Model, JEDEC: J	ESD22-C101	-	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.50	5.50	1
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage	Active State	0	V <sub>CC</sub>	V
		Three-State	0	5.5	1
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	V <sub>CC</sub> at 1.8 V, 2.5 V ±0.2 V	0	20	ns/V
		V <sub>CC</sub> at 3.3 V ±0.3 V	0	10	1
		V <sub>CC</sub> at 5.0 V ±0.5 V	0	5	1
$\theta_{\sf JA}$	Thermal Resistance	SC-74A / SOT23-5	-	320	°C/W
		SC-88A	-	377	1
		MicroPak-6	-	154	1
		MicroPak2-6	-	154	1

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

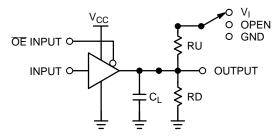
### DC ELECTRICAL CHARACTERISTICS

				T	\ = +25°	°C	$T_A = -40$	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>	-	-	0.65 V <sub>CC</sub>	-	V
		2.30 to 5.50		0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	
V <sub>IL</sub>	LOW Level Input Voltage	1.65 to 1.95		-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V
		2.30 to 5.50		-	_	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	1
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	$V_{IN} = V_{IH}$ or $V_{IL}$ ,	1.55	1.65	-	1.55	-	V
		1.80	I <sub>OH</sub> = -100 μA	1.70	1.80	-	1.70	-	
		2.30		2.20	2.30	-	2.20	_	1
		3.00		2.90	3.00	-	2.90	_	1
		4.50		4.40	4.50	-	4.40	-	1
		1.65	$I_{OH} = -4 \text{ mA}$	1.29	1.52	-	1.29	_	1
		2.30	$I_{OH} = -8 \text{ mA}$	1.90	2.15	-	1.90	_	
		3.00	I <sub>OH</sub> = -16 mA	2.40	2.80	-	2.40	-	
		3.00	I <sub>OH</sub> = -24 mA	2.30	2.68	-	2.30	-	
		4.50	$I_{OH} = -32 \text{ mA}$	3.80	4.20	-	3.80	_	1
V <sub>OL</sub>	LOW Level Output Voltage	1.65	$V_{IN} = V_{IH}$ or $V_{IL}$ ,	-	0.00	0.10	-	0.00	V
		1.80	I <sub>OL</sub> = 100 μA	_	0.00	0.10	-	0.10	1
		2.30		_	0.00	0.10	-	0.10	
		3.00		_	0.00	0.10	-	0.10	1
		4.50		_	0.00	0.10	-	0.10	1
		1.65	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24	
		2.30	I <sub>OL</sub> = 8 mA	-	0.10	0.30	-	0.30	
		3.00	I <sub>OL</sub> = 16 mA	-	0.15	0.40	-	0.40	
		3.00	I <sub>OL</sub> = 24 mA	-	0.22	0.55	-	0.55	
		4.50	I <sub>OL</sub> = 32 mA	-	0.22	0.55	-	0.55	
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	$0 \ge V_{IN} \ge 5.5 \text{ V}$	-	-	±1	-	±10	μΑ
I <sub>OZ</sub>	3-STATE Output Leakage	0 to 5.5	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $0 \ge V_O \ge 5.5 \text{ V}$	-	-	±1	-	±10	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V	_	-	1	-	10	μΑ
Icc	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> = 5.5 V, GND	-	_	2	_	20	μΑ

### **AC ELECTRICAL CHARACTERISTICS**

				٦	Γ <sub>A</sub> = +25°0	;	$T_A = -40$	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay (Figure 4, 6)	1.65	C <sub>L</sub> = 15 pF,	_	6.4	13.2	-	13.8	ns
		1.80	$R_D = 1 M\Omega$ $S_1 = OPEN$	_	5.3	11.0	-	11.5	
		2.50 ±0.20	1	_	3.4	7.5	-	8.0	
		3.30 ±0.30	]	-	2.5	5.2	-	5.5	
		5.00 ±0.50	1	_	2.1	4.5	-	4.8	
		3.30 ±0.30	C <sub>L</sub> = 50 pF,	_	3.2	5.7	-	6.0	
		5.00 ±0.50	$R_D = 500 \Omega$ $S_1 = OPEN$	-	2.6	5.0	-	5.3	
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time	1.65	$C_L = 50 \text{ pF},$ $R_D = 500 \Omega$ $RU = 500 \Omega$ $S_1 = GND \text{ for } t_{PZH}$ $S_1 = V_{IN} \text{ for } t_{PZL}$	-	8.4	15.0	-	15.6	ns
	(Figure 4, 6)	1.80		_	7.0	12.5	-	13.0	
		2.50 ±0.20		_	4.6	8.5	-	9.0	
		3.30 ±0.30	$V_{IN} = 2 \cdot V_{CC}$	_	3.5	6.2	-	6.5	
		5.00 ±0.50	]	1	2.8	5.5	-	5.8	
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time	1.65	C <sub>L</sub> = 50 pF,	_	6.5	13.2	-	14.5	
	(Figure 4, 6)	1.80	$R_D = 500 \Omega$ $RU = 500 \Omega$	_	5.4	11.0	-	12.0	
		2.50 ±0.20	$S_1 = GND \text{ for } t_{PHZ}$ $S_1 = V_{IN} \text{ for } t_{PLZ}$	_	3.5	8.0	-	8.5	
		3.30 ±0.30	$V_{IN} = 2 \cdot V_{CC}$	_	2.8	5.7	-	6.0	
		5.00 ±0.50	1	_	2.1	4.7	-	5.0	
C <sub>IN</sub>	Input Capacitance	0.00		ı	4	-	-	_	pF
C <sub>OUT</sub>	Output Capacitance	0.00		ı	8	-	_	_	
C <sub>PD</sub>	Power Dissipation Capacitance (Note 2) (Figure 5)	3.30		-	17	-	-	-	pF

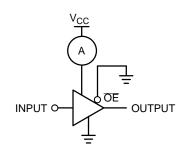
<sup>2.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:
I<sub>CCD</sub> = (C<sub>PD</sub>) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CC</sub>static).



### NOTE:

3.  $C_L$  includes load and stray capacitance; Input PRR = 1.0 MHz;  $t_W$  = 500 ns

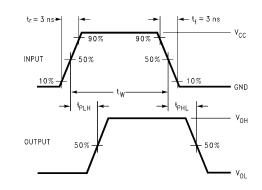
Figure 4. AC Test Circuit



### NOTE:

4. Input = AC Waveform;  $t_r = t_f = 1.8$  ns; PRR = 10 MHz; Duty Cycle = 50%.

Figure 5. I<sub>CCD</sub> Test Circuit



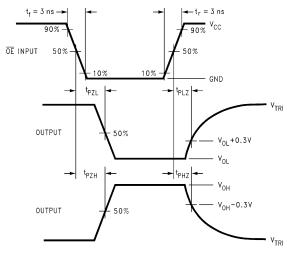


Figure 6. AC Waveforms

### ORDERING INFORMATION

Part Number	Top Mark	Operating Temperature	Packages	Shipping <sup>†</sup>
NC7SZ125M5X	7Z25	−40 to +85°C	SC-74A	3000 / Tape & Reel
NC7SZ125P5X	Z25	−40 to +85°C	SC-88A	3000 / Tape & Reel
NC7SZ125L6X	DD	−40 to +85°C	MicroPak	5000 / Tape & Reel
NC7SZ125FHX	DD	−40 to +85°C	MicroPak2	5000 / Tape & Reel

### **DISCONTINUED** (Note 5)

NC7SZ125M5X-L22090	7Z25	−40 to +85°C	SOT23-5	3000 / Tape & Reel
NC7SZ125P5X-F22057	Z25	−40 to +85°C	SC-88A	3000 / Tape & Reel
NC7SZ125L6X-L22175	DD	−40 to +85°C	MicroPak	5000 / Tape & Reel
NC7SZ125FHX-L22175	DD	−40 to +85°C	MicroPak2	5000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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<sup>5.</sup> **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <a href="https://www.onsemi.com">www.onsemi.com</a>.



**ISSUE O DATE 31 AUG 2016** 2X 0.05 C 1.45 В 2X (1) $\bigcirc$  0.05 C (0.49)(0.254)1.00 5X \ (0.75)(0.52)TOP VIEW Α 1X L PIN 1 IDENTIFIER /5\ 0.50±0.05 (0.30)6X PIN 1 0.05 RECOMMENED 0.00 LAND PATTERN 0.05 C - 0.35±0.05 С 1.45±0.05 -0.20±0.05 6X DETAIL A 1.0 0.10M|C|B|A

0.05(M)

0.30±0.05 5X

0.35±0.05 5X

(0.125)

4X

**SIP6 1.45X1.0** CASE 127EB

NOTES:

1.00±0.05

(0.050)

6X

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD

0.5

- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009

**BOTTOM VIEW** 

- 4.PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
  - OTHER LINE IN THE MARK CODE LAYOUT.

DOCUMENT NUMBER:	98AON13590G	Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	SIP6 1.45X1.0		PAGE 1 OF 1

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0.40±0.05

**PIN 1 TERMINAL** 

**DETAIL** A

0.075 X 45°

CHAMFER

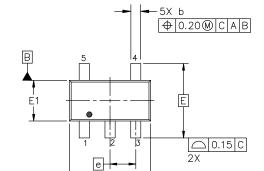


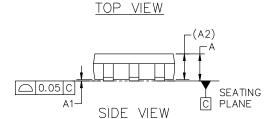
A

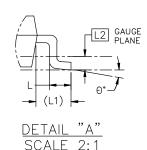


### SC-74A-5 3.00x1.50x0.95, 0.95P CASE 318BQ ISSUE C

**DATE 26 FEB 2024** 







# GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code

M = Date Code

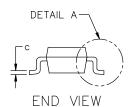
= Pb-Free Package

(Note: Microdot may be in either location)

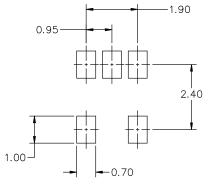
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

### NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- 2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.



DIM	М	ILLIMETER	RS	
DIIVI	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.01	0.18	0.10	
A2	(	0.95 REF		
b	0.25	0.37	0.50	
С	0.10	0.18	0.26	
D	2.85	3.00	3.15	
Е	:	2.75 BSC	;	
E1	1.35	1.50	1.65	
е	(	0.95 BSC	)	
L	0.20	0.40	0.60	
L1	0.62 REF.			
L2	0.25 BSC			
Θ	0,	5*	10°	



### RECOMMENDED MOUNTING FOOTPRINT\*

\* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

DOCUMENT NUMBER:	98AON66279G	Electronic versions are uncontrolled except when accessed directly fron Printed versions are uncontrolled except when stamped "CONTROLLEI	
DESCRIPTION	SC-74A-5 3.00x1.50x0.95	0.95P	PAGE 1 OF 1

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### SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

**DATE 11 APR 2023** 

### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETERS
- OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS			
ואונת	MIN.	N□M.	MAX.	
А	0.80	0.95	1.10	
A1			0.10	
A3	0.20 REF			
b	0.10	0.20	0.30	
C	0.10		0.25	
D	1.80	2.00	2,20	
Е	2.00	2.10	2.20	
E1	1.15	1.25	1.35	
е	0.65 BSC			
L	0.10	0.15	0.30	

- 419A-01 DBSDLETE, NEW STANDARD 419A-02
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS,

	L <del> </del> <del> </del>		
<u> </u>	0.50	5	

5X b

◆ 0.2 M B M

### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

5. COLLECTOR

### **GENERIC MARKING DIAGRAM\***



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4
STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE 1	STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER	STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE	Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

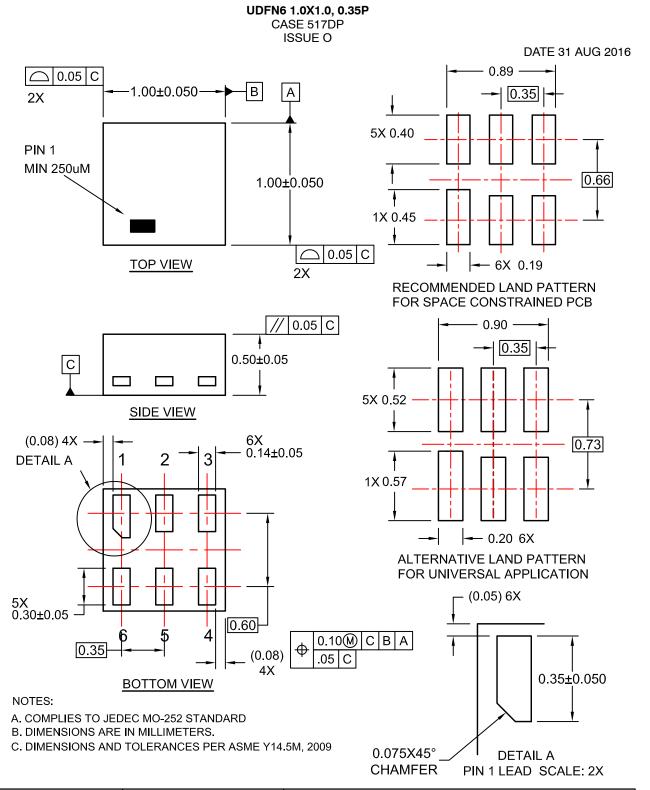
DOCUMENT NUMBER:	98ASB42984B	Electronic versions are uncontrolled except when accessed directly from the Document Reposito Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SC-88A (SC-70-5/SOT-353)		PAGE 1 OF 1	

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5. COLLECTOR 2/BASE 1





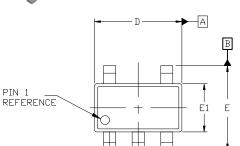


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DESCRIPTION:	UDFN6 1.0X1.0, 0.35P		PAGE 1 OF 1

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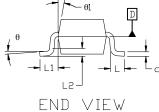






# 

TOP VIEW



# GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

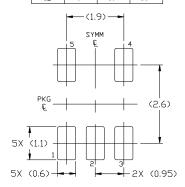
### SOT-23, 5 Lead CASE 527AH ISSUE A

**DATE 09 JUN 2021** 

### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS.
   MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED O. 25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- 5. DIMENSION '6' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE '6' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.90	_	1.45	
A1	0.00	_	0.15	
A2	0.90	1.15	1.30	
b	0.30	_	0.50	
C	0.08	_	0.22	
D	2.90 BSC			
Ε	2.80 BSC			
E1	1.60 BSC			
е	0.95 BSC			
L	0.30	0.45	0.60	
L1	0.60 REF			
L2	0.25 REF			
θ	0°	4°	8°	
θ1	0°	10°	15°	
θ2	0°	10°	15°	



# RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDL DERRM/D.

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DESCRIPTION:	SOT-23, 5 LEAD		PAGE 1 OF 1

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